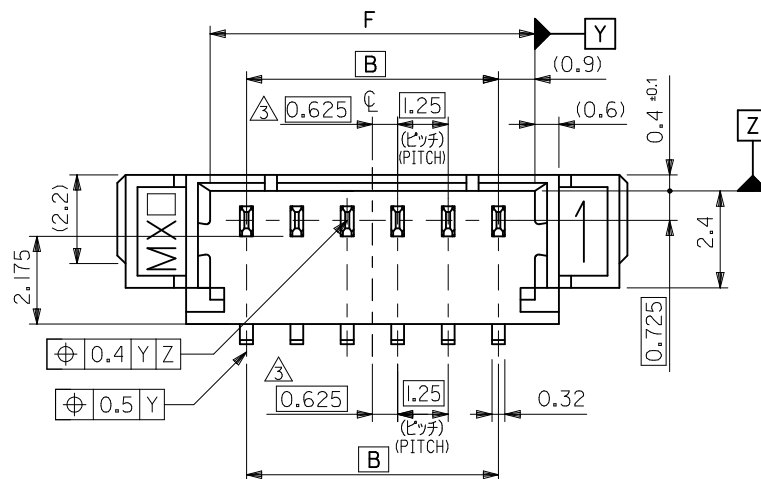
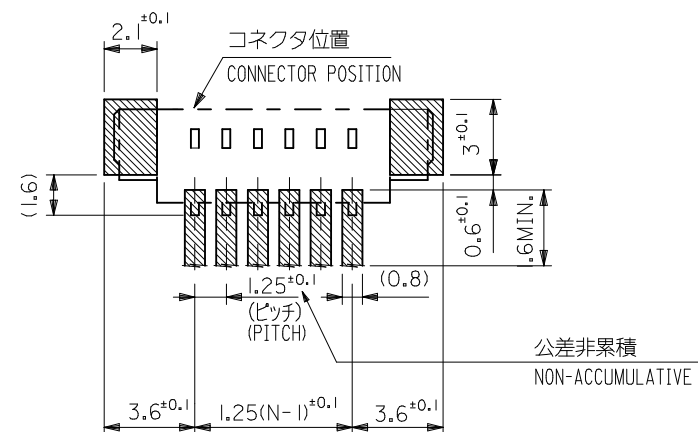
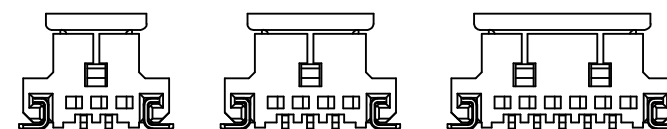




カバーなしの場合 (53398-***19)
IN CASE OF WITHOUT COVER



参考基板レイアウト
RECOMMENDED P.C.BOARD PATTERN DIM.(REF.)



2極
2 CKT.

3極
3 CKT.

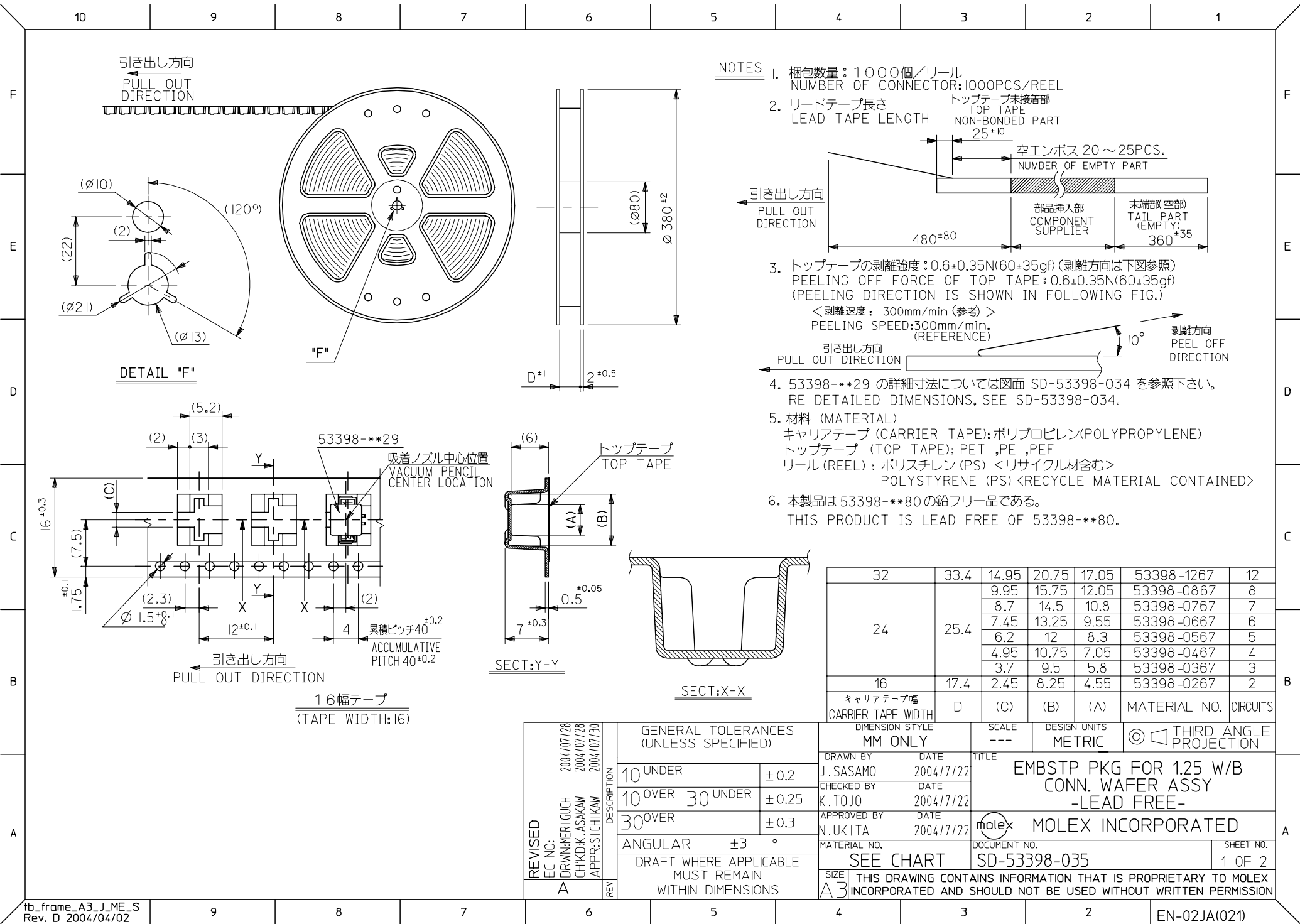
4極以上
OVER 4 CKT.

ロック形状図
LOCK CONFIGURATION

NOTES

- ロック窓は、2、3極は1ヶ所、4極以上は2ヶ所とする。
LOCKING WINDOW : ONE PLACE FOR 2&3 CKTS.
TWO PLACES FOR MORE THAN 4 CKTS.
- ソルダートール及び金具の平坦度は0.1以下。
SOLDER TAIL & FITTING NAIL COPLANARITY TO BE 0.1 MAX.
- ELV及びRoHS適合品
ELV AND RoHS COMPLIANT.

REVISED	EC NO: J2016-1122	DRWN: QHE31	CHKD: SAKIYAMA	APPR: KANEKO	2016/04/27	2016/05/06	2016/05/06	MODEL NO. 53398-***29		THIRD ANGLE PROJECTION
								GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE MM ONLY	
								0.25 UNDER UNDER ±0.03	DRAWN BY Y.SAKIYAMA	
								0.25 OVER 0.5 UNDER ±0.05	DATE 2004/02/12	
A	REV	DESCRIPTION	0.5 OVER 1.0 UNDER ±0.1	1.0 OVER 10 UNDER ±0.2	10 OVER 30 UNDER ±0.25	30 OVER ±0.3	ANGULAR ±3 °	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION



F

E

D

C

B

A

F

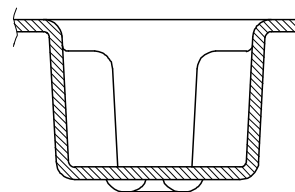
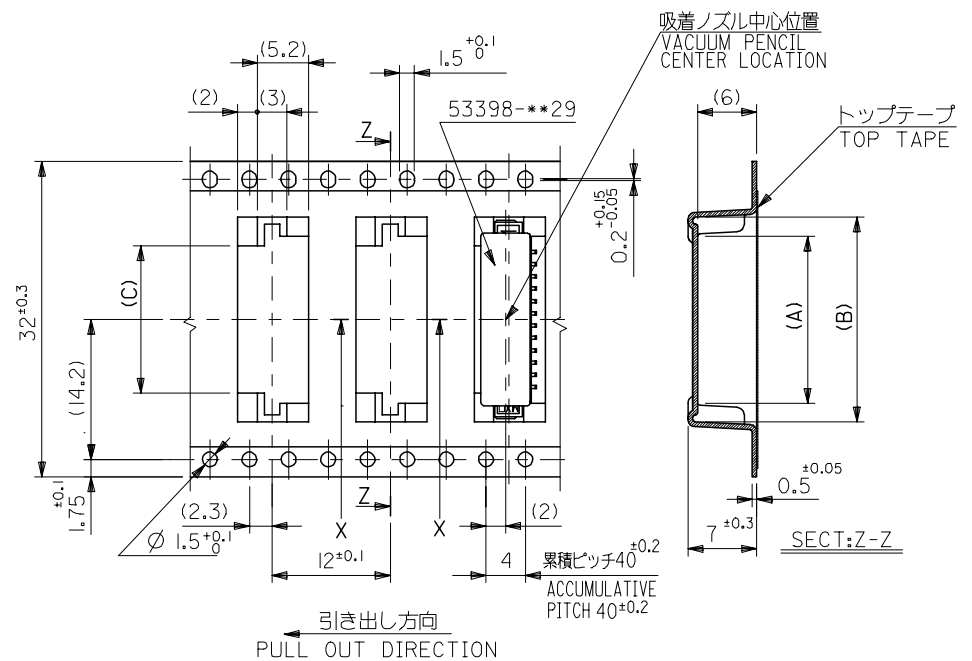
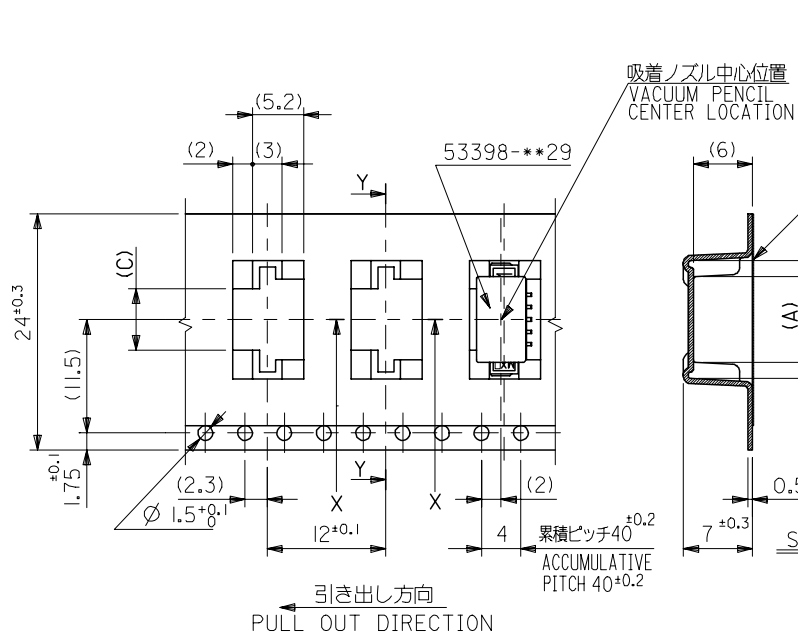
E

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SECT:X-X

REVISED EC NO: A	2004/07/28 2004/07/28 2004/07/30	DESCRIPTION DRAWN:MERUGUCH CHK:K: ASAKAW APP: S: CHIKAW	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION	
			10 UNDER	±0.2	DRAWN BY J. SASAMO	DATE 2004/7/22	TITLE EMBSTP PKG FOR 1.25 W/B CONN. WAFER ASSY -LEAD FREE-			
			10 OVER 30 UNDER	±0.25	CHECKED BY K. TOJO	DATE 2004/7/22				
			30 OVER	±0.3	APPROVED BY N. UKITA	DATE 2004/7/22	MOLEX INCORPORATED			
			ANGULAR	±3 °	MATERIAL NO. SEE CHART					
REV			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				